PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Michael Noel Morrissey	10/05/2012
Bernard Patrick Stenson	10/05/2012

RECEIVING PARTY DATA

Name:	Analog Devices, Inc.
Street Address:	One Technology Way
City:	Norwood
State/Country:	MASSACHUSETTS
Postal Code:	02062

PROPERTY NUMBERS Total: 1

Property	Туре	Number
Application Number	r:	13646940

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	ADIRE.053A
NAME OF SUBMITTER:	Aaron M. Davis
Signature:	/Aaron M. Davis/
Date:	09/20/2013
	PATENT

502503362 REEL: 031248 FRAME: 0859

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This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 4

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COMBINED DECLARATION & ASSIGNMENT (37 CFR 1.63(e))

Application Data Sheet filed previously or concurrently

Docket No.: ADIRE.053A Page 1 of 4

Title: METHODS OF FORMING A THIN FILM RESISTOR

Inventors: Michael Noel Morrissey and Bernard Patrick Stenson

Declaration

This Declaration is directed to the invention identified above that:

Is attached, where "attached" means filed concurrently with.

As a named inventor, I declare that:

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the above-identified application, including the claims, as amended by any amendment.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.

Assignment from Inventors

WHEREAS, the **above-identified inventors** (individuals hereinafter "ASSIGNOR") invented certain new and useful improvements, technology, inventions, developments, ideas or discoveries, and hereby assign or are under an obligation to assign to the below identified Assignee the above-titled application (collectively hereinafter referred to as the "Work") for which an application for Letters Patent in the United States (identified above) has been prepared for filing with the United States Patent and Trademark Office (hereinafter the "Application").

AND WHEREAS, **Analog Devices**, **Inc.**, a Massachusetts corporation, with its principal place of business at One Technology Way, Norwood, MA 02062 (hereinafter the "ASSIGNEE"), desires to acquire the entire right, title, and interest in and to the Application and the Work.

NOW, THEREFORE, for good and valuable consideration of which receipt is hereby acknowledged, ASSIGNOR hereby acknowledges that ASSIGNOR has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in the Application and the Work, including all patent properties filed or issued upon the Application and the Work; where "Patent Properties" include, but are not limited to:

all provisional applications relating thereto;

all nonprovisional applications claiming priority to aforementioned provisional(s) and/or the present Application, including, all divisions, continuations, continuations-in-part, and reissues, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof; and

all rights of priority under International Conventions and any related Letters Patent which may hereafter be granted or filed in any country or countries foreign to the United States, all extensions, renewals and reissues thereof.

ASSIGNOR hereby acknowledges the ASSIGNEE as the Applicant for all aforementioned patent properties, and authorizes and requests the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on

COMBINED DECLARATION & ASSIGNMENT (37 CFR 1.63(e))

Application Data Sheet filed previously or concurrently

Docket No.: ADIRE.053A Page 2 of 4

Title: METHODS OF FORMING A THIN FILM RESISTOR

Inventors: Michael Noel Morrissey and Bernard Patrick Stenson

applications as aforesaid, to issue all related Letters Patent to the ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND ASSIGNOR DOES HEREBY sell, assign, transfer, and convey to ASSIGNEE, its successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEE, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of said Letters Patent before or after issuance.

AND ASSIGNOR DOES HEREBY covenant and agree that ASSIGNOR will communicate to said ASSIGNEE, its successors, legal representatives and assigns, any facts known to ASSIGNOR respecting the Work, and testify in any legal proceeding, assist in the preparation of any other Patent Property relating to the Application and the Work or any improvements made thereto, sign/execute all lawful papers, execute and make all rightful oaths and/or declarations in connection with the Application and the Work including any improvements made thereto, any patent applications filed therefrom, and any continuing application filed from any of the aforementioned applications, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for the Work in all countries.

COMBINED DECLARATION & ASSIGNMENT (Application Data Sheet filed previously or cond			3(e)) 	
Docket No.: ADIRE.053A			Pag	e 3 of 4
Title: METHODS OF FORMING A THIN FILM RESISTOR	*			
Inventors: Michael Noel Morrissey and Bernard Patrick Stenson				
				-
Legal Name of inventor: Michael Noel Morrissey				
Signature: While Was July	Date:	54h	ocioper	2012
Witnessed by: Pat M. Crimman			<u> </u>	
Witness Name (printed): PAY MC (citivalation)				

	cket No.: ADIRE.053A Page		4 of 4	
Title: METHODS OF	FORMING A THIN FILM RESISTOR			
nventors: Michael No	el Morrissey and Bernard Patrick Stenson			
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_egal Name of inven	tor: Bernard Patrick Stenson			
	Beind Sterrou	Date: 5th October	/	
Signature: _	<u> </u>	0.000		
Signature: _	Witnessed by: P. of M. Crimmity	<u> </u>		

PATENT REEL: 031248 FRAME: 0864

RECORDED: 09/20/2013